MAX3232 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER

- **RS-232 Bus-Pin ESD Protection Exceeds** ±15 kV Using Human-Body Model (HBM)
- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V V_{CC} Supply
- **Operates Up To 250 kbit/s**
- **Two Drivers and Two Receivers**
- Low Supply Current . . . 300 µA Typical
- External Capacitors . . . $4 \times 0.1 \ \mu F$
- Accepts 5-V Logic Input With 3.3-V Supply
- **Alternative High-Speed Pin-Compatible** Device (1 Mbit/s) - SNx5C3232
- **Applications** - Battery-Powered Systems, PDAs, Notebooks, Laptops, Palmtop PCs, and Hand-Held Equipment

description/ordering information

		/, OR PW P/ TOP VIEW)	ACKAGE
DY.COM.TW DOY.COM.TW 100Y.COM.TW 100Y.COM.TW 100Y.COM.T N.100Y.COM.T N.100Y.COM	C1+ [1 V+ [2 C1- [3 C2+ [4 C2- [5 V- [6 DOUT2 [7 RIN2 [8	16 15 14 13 12 12 11 10 9 9	V _{CC} GND DOUT1 RIN1 ROUT1 DIN1 DIN2 ROUT2

WITH ±15-kV ESD PROTECTION SLLS410I - JANUARY 2000 - REVISED JANUARY 2004

VW.1001	勝特力材米	¥ 886-3-5753170
WW.10	胜特力电子(上海	e) 86-21-54151736
WWW.L	胜特力电子(深圳) 86-755-83298787
WWW.I	Http://www	v. 100y. com. tw

WW.100Y.C

TA	PACK	AGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0010 (D)	Tube of 40	MAX3232CD	144,700000
	SOIC (D)	Reel of 2500	MAX3232CDR	MAX3232C
		Tube of 40	MAX3232CDW	
–0°C to 70°C	SOIC (DW)	Reel of 2000	MAX3232CDWR	MAX3232C
	0000 (00)	Tube of 80	MAX3232CDB	14400000
	SSOP (DB)	Reel of 2000	MAX3232CDBR	MA3232C
		Tube of 90	MAX3232CPW	
	TSSOP (PW)	Reel of 2000	MAX3232CPWR	MA3232C
	0010 (D)	Tube of 40	MAX3232ID	MANADOOL
	SOIC (D)	Reel of 2500	MAX3232IDR	MAX32321
		Tube of 40	MAX3232IDW	
1000 to 0500	SOIC (DW)	Reel of 2000	MAX3232IDWR	MAX32321
10°C to 85°C		Tube of 80	MAX3232IDB	MPagaal
	SSOP (DB)	Reel of 2000	MAX3232IDBR	MB3232I
-40°C to 85°C		Tube of 90	MAX3232IPW	MD20201
	TSSOP (PW)	Reel of 2000	MAX3232IPWR	— MB3232I

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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MAX3232 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH +15-kV ESD PROTECTION

SLLS410I - JANUARY 2000 - REVISED JANUARY 2004

description/ordering information (continued)

The MAX3232 device consists of two line drivers, two line receivers, and a dual charge-pump circuit with ±15-kV ESD protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. The devices operate at data signaling rates up to 250 kbit/s and a maximum of 30-V/µs driver output slew rate.

Function Tables

EACH	DRIVER
INPUT DIN	OUTPUT DOUT
L	Ĥ
Н	LTV.
H = high I	evel, L = low

level

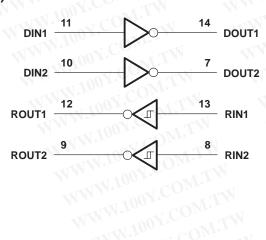
EACH RECEIVER

L.	INPUT RIN	OUTPUT ROUT	
~	TL	Н	
7.4	H	L 📢	
0	Open	н	

H = high level, L = low level, Open = input disconnected or connected driver off

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logic diagram (positive logic)





MAX3232 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH +15-kV ESD PROTECTION

SLLS410I - JANUARY 2000 - REVISED JANUARY 2004

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} (see Note	1)	–0.3 V to 6 V
	V+ (see Note 1)	
	V- (see Note 1)	
	e Note 1)	
Input voltage range, V _I : Drivers		–0.3 V to 6 V
Output voltage range, Vo: Drivers		–13.2 V to 13.2 V
	177	
Package thermal impedance, θ_{IA} (see	Notes 2 and 3): D package	
Nor 1001.5 OM. Tom		82°C/W
	DW package	57°C/W
	PW package	108°C/W
Operating virtual junction temperature	, TJ	150°C
0.9		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltages are with respect to network GND.

2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4 and Figure 4)

	WW.In COM.	WW	N. POS.COM	MIN	NOM	MAX	UNIT
	M.100 M.1		V _{CC} = 3.3 V	3	3.3	3.6	
	Supply voltage		$V_{CC} = 5 V$	4.5	5		V
V	H Driver high-level input voltage	DIN	V _{CC} = 3.3 V	2	N	~	
VIH	Driver nign-level input voltage		$V_{CC} = 5 V$	2.4	W		V
VIL	Driver low-level input voltage		DIN	COM.		0.8	V
	Driver input voltage	TW	DIN	0	1.1.1	5.5	
VI	Receiver input voltage	$V_{CC} = 5 V$ $V_{CC} = 3.3 V$ $V_{CC} = 5 V$ $V_{CC} = 5 V$ DIN	-25	NT.N	25	V	
т.	CO. W.	W	MAX3232C	0	17.	70	
Τ _Α	Supply voltage V _{CC} = 5 Driver high-level input voltage DIN Driver low-level input voltage DIN Driver input voltage DIN Receiver input voltage DIN Operating free-air temperature MAX323	MAX3232I	-40	DNr.	85	°C	

NOTE 4: Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V ± 0.5 V.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 4)

PARAMETER	TEST CONDITIONS	MIN TYP [‡] MAX UNIT
ICC Supply current	No load, $V_{CC} = 3.3 \text{ V or } 5 \text{ V}$	0.3 1 mA

[‡] All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

NOTE 4: Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V ± 0.5 V.

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MAX3232 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH +15-kV ESD PROTECTION

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DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 4)

	PARAMETER	TEST COND	ITIONS	MIN	TYP [†]	MAX	UNIT
Vон	High-level output voltage	DOUT at $R_L = 3 k\Omega$ to GND,	DIN = GND	5	5.4	JO 7	V
VOL	Low-level output voltage	DOUT at $R_L = 3 k\Omega$ to GND,	$DIN = V_{CC}$	-5	-5.4	1001.	V
IIН	High-level input current	$V_{I} = V_{CC}$	N.COM	1	±0.01	±1	CμA
۱ _{IL}	Low-level input current	V _I at GND	COM		±0.01	±1	μA
1t	1002.	V _{CC} = 3.6 V,	VO = 0 V		105		
los‡	Short-circuit output current	V _{CC} = 5.5 V,	VO = 0 V	±35	±60	mA	
r _o	Output resistance	V_{CC} , V+, and V- = 0 V,	$V_0 = \pm 2 V$	300	10M	14	Ω

[†] All typical values are at $V_{CC} = 3.3$ V or $V_{CC} = 5$ V, and $T_A = 25^{\circ}$ C.

[‡] Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

NOTE 4: Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V ± 0.5 V.

switching characteristics over recommended ranges of supply voltage and operating free-air OY.COM.T temperature (unless otherwise noted) (see Note 4 and Figure 4)

	PARAMETER	TEST C	ONDITIONS	MIN	TYP† I	MAX	UNIT
	Maximum data rate	C _L = 1000 pF, One DOUT switching,	R _L = 3 kΩ, See Figure 1	150	250	4	kbit/s
^t sk(p)	Pulse skew§	C _L = 150 pF to 2500 pF	$R_L = 3 k\Omega$ to 7 kΩ, See Figure 2		300		ns
	Slew rate, transition region (see Figure 1)	$R_L = 3 k\Omega$ to 7 kΩ, V _{CC} = 3.3 V	C _L = 150 pF to 1000 pF	6		30	V/µs
SR(tr)			$C_{I} = 150 \text{ pF} \text{ to } 2500 \text{ pF}$	4		30	

NOTE 4: Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V ± 0.5 V.



MAX3232 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH \pm 15-kV ESD PROTECTION

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RECEIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 4)

N.	PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
Vон	High-level output voltage	$I_{OH} = -1 \text{ mA}$	V _{CC} -0.6V	V _{CC} -0.1 V	100	V
VOL	Low-level output voltage	I _{OL} = 1.6 mA	NN.	1005	0.4	V
V _{IT+}	Positive-going input threshold voltage	V _{CC} = 3.3 V	N	1.5	2.4	
		$V_{CC} = 5 V$		1.8	2.4	V.
	MAN 100X.C. M.T.M.	V _{CC} = 3.3 V	0.6	1.2	JU 1.	Mo.
V _{IT} –	Negative-going input threshold voltage	V _{CC} = 5 V	0.8	1.5	001.	V
V _{hys}	Input hysteresis (V _{IT+} – V _{IT} _)	WWW.P. CON.	W	0.3	Loon Y	V
ri	Input resistance	$V_{I} = \pm 3 V \text{ to } \pm 25 V$	3	5	7	kΩ

[†] All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

NOTE 4: Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V ± 0.5 V.

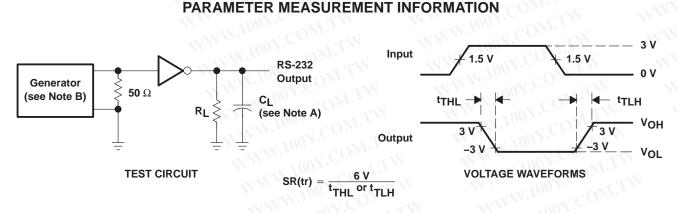
switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 3)

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output	0 450 5	300	VW	ns
^t PHL	Propagation delay time, high- to low-level output	CL= 150 pF	300		ns
^t sk(p)	Pulse skew [‡]	WWW TOOX.COM	300	A. V.	ns

[†] All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

[‡]Pulse skew is defined as |tpLH - tpHL| of each channel of the same device.

NOTE 4: Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V ± 0.5 V.



NOTES: A. CL includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s, $Z_O = 50 \Omega$, 50% duty cycle, $t_f \le 10$ ns. $t_f \le 10$ ns.

Figure 1. Driver Slew Rate

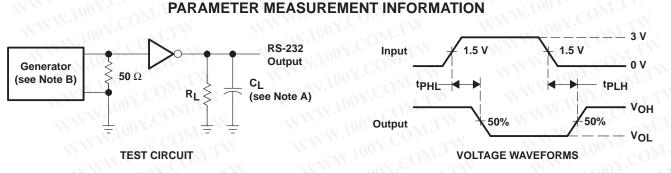
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MAX3232 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm 15\text{-kV}$ ESD PROTECTION

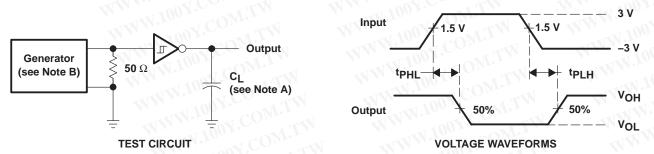
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- NOTES: A. CL includes probe and jig capacitance.
 - B. The pulse generator has the following characteristics: PRR = 250 kbit/s, $Z_0 = 50 \Omega$, 50% duty cycle, $t_r \le 10$ ns, $t_f \le 10$ ns.

Figure 2. Driver Pulse Skew



- NOTES: A. CL includes probe and jig capacitance.
 - B. The pulse generator has the following characteristics: $Z_0 = 50 \Omega$, 50% duty cycle, $t_f \le 10$ ns. $t_f \le 10$ ns.

Figure 3. Receiver Propagation Delay Times

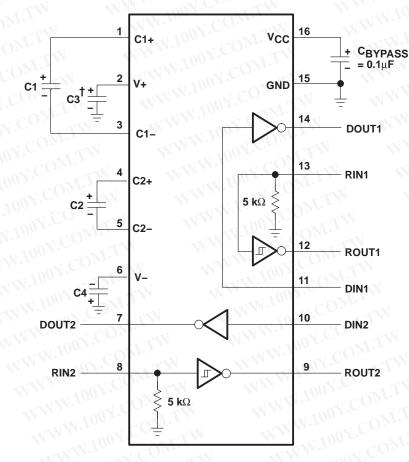


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MAX3232 **3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER** WITH ±15-kV ESD PROTECTION

SLLS410I - JANUARY 2000 - REVISED JANUARY 2004

APPLICATION INFORMATION



[†]C3 can be connected to V_{CC} or GND.

- NOTES: A. Resistor values shown are nominal.
 - B. Nonpolarized ceramic capacitors are acceptable. If polarized tantalum or electrolytic capacitors are used, they should be connected as shown.

4	Vcc	C1	C2, C3, C4	
	3.3 V ± 0.3 V 5 V ± 0.5 V	0.1 μF 0.047 μF	0.1 μF 0.33 μF	
	3 V to 5.5 V	0.047 μF 0.1 μF	0.33 μF 0.47 μF	

VCC vs CAPACITOR VALUES

WWW.100Y.COM. WWW.100Y.COM.TW Figure 4. Typical Operating Circuit and Capacitor Values





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PACKAGE OPTION ADDENDUM

4-Mar-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finis	h MSL Peak Temp ⁽³⁾
MAX3232CD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232CDB	ACTIVE	SSOP	DB	16	80	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232CDBR	ACTIVE	SSOP	DB	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232CDR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232CDW	ACTIVE	SOIC	DW	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
MAX3232CDWR	ACTIVE	SOIC	DW 🔨	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
MAX3232CPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
MAX3232CPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
MAX3232ID	ACTIVE	SOIC	TWD	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232IDB	ACTIVE	SSOP	DB	16	80	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232IDBR	ACTIVE	SSOP	DB	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232IDR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
MAX3232IDW	ACTIVE	SOIC	DW	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
MAX3232IDWR	ACTIVE	SOIC	DW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
MAX3232IPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
MAX3232IPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.



PACKAGE OPTION ADDENDUM

4-Mar-2005

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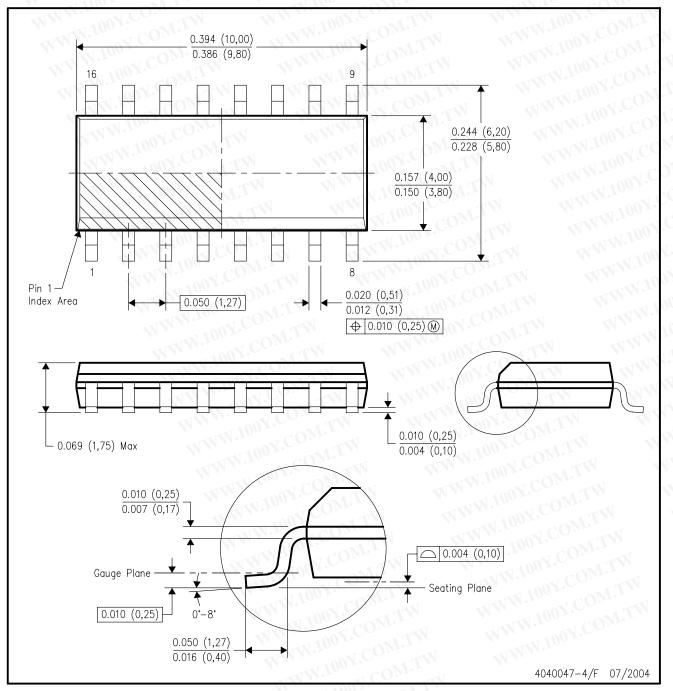
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D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.

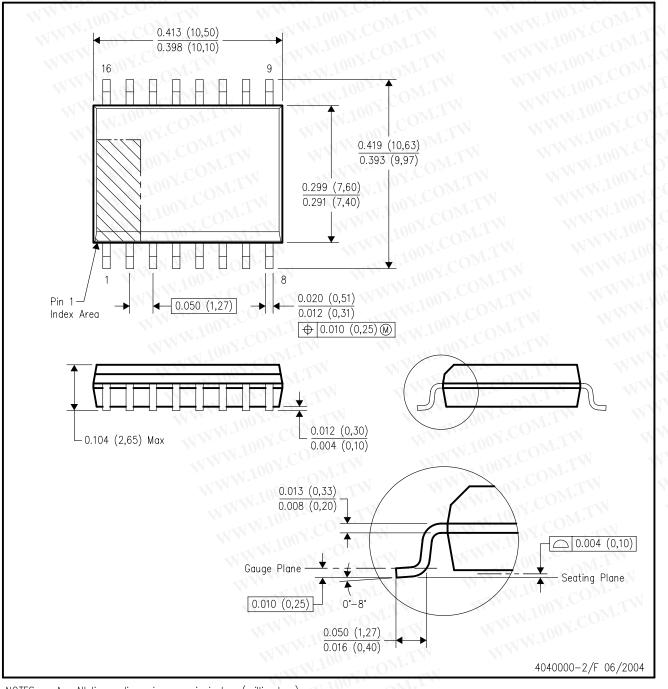




MECHANICAL DATA

DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AA.



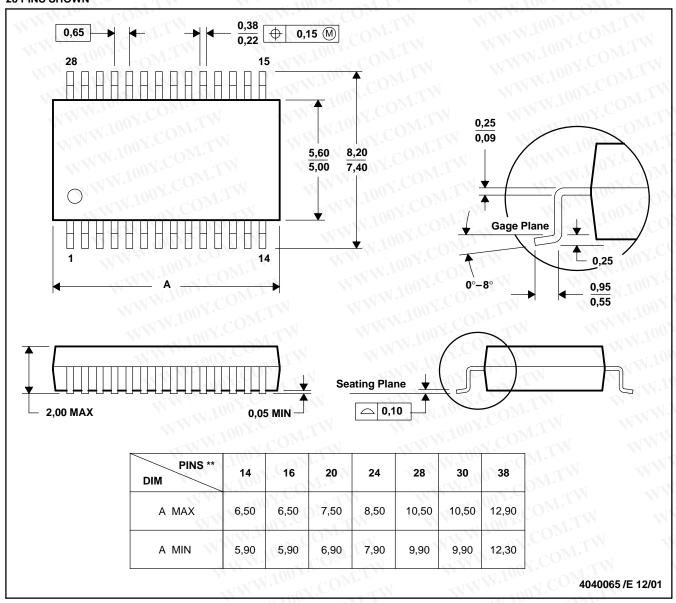
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MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**) 28 PINS SHOWN





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



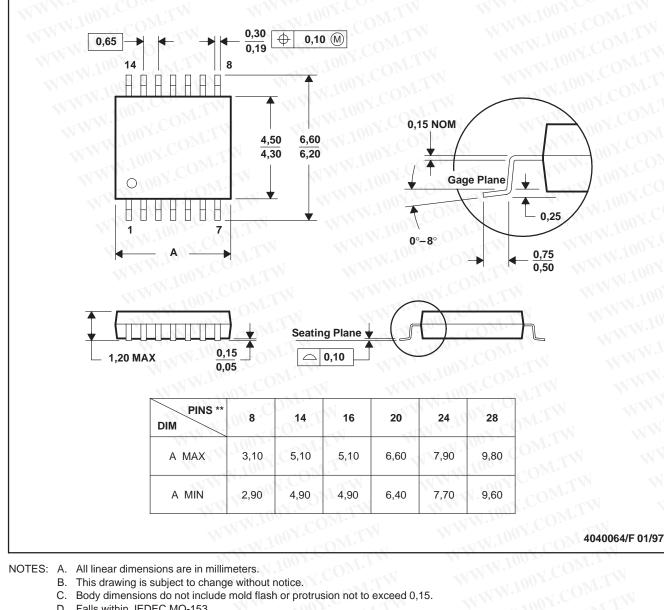


MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**) **14 PINS SHOWN**

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- This drawing is subject to change without notice. В.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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